501821884 02/15/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hua-Chou TSENG	02/08/2012
Meng-Wei HSIEH	02/08/2012

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	No. 8, Li-Hsin Rd. VI, Hsinchu Science Park	
City:	Hsinchu	
State/Country:	Country: TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13397465

CORRESPONDENCE DATA

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via US Mail.

Correspondent Name: Lowe Hauptman Ham & Berner, LLP (TSMC)

Address Line 1: 1700 Diagonal Road, Suite 300 Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: T5057-674

NAME OF SUBMITTER: Randy A. Noranbrock

Total Attachments: 1

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PATENT REEL: 027711 FRAME: 0428 OP \$40.00 13397465

501821884

Docket No. T5057-674 TSMC2011-1425

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Hua-Chou TSENG
- 2) Meng-Wei HSIEH

who l	nas made a certain new and useful invention, hereby sells, assigns and transfers unto				
TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD. having a place of business at No 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.					
<u>DUN</u>	MMY GATE FOR A HIGH VOLTAGE TRANSISTOR DEVICE				
(a)	for which an application for United States Letters Patent was filed on 2012-02-15 , and identified by United States Patent Application No. 13/397, 465 ; or				
(b)	for which an application for United States Letters Patent was executed on,				
	ne undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and nited States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or				

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

RECORDED: 02/15/2012

1) Jana. Char Zan	Feb. 108 /2012
Name: Hua-Chou TSENG	Date:
2) Mong Wei HSIEH	Feb/08/2012
Name: Meng Wei HSIEH	Date:

PATENT REEL: 027711 FRAME: 0429